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COVER SHEET  
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1. Name of conveying party(ies):

Takuya YAMAZAKI, Yasuhiro MAENISHI, Ikuo YOSHIDA,  
Akihito YAMASAKI

Additional name(s) of conveying party(ies) attached? No

2. Name and address of receiving party(ies):

Name: Matsushita Electric Industrial Co., Ltd.

Street Address: 1006, Oaza Kadoma, Kadoma-shi,  
Osaka 571-8501 Japan

Additional name(s) & address(es) attached? No

3. Nature of conveyance:

☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other

Execution Date: March 15, 2005, March 16, 2005, March 28,  
2005

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: March 15, 2005,  
March 16, 2005, March 28, 2005

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? No

5. Name and address of party to whom correspondence  
concerning document should be mailed:

Name: WENDEROTH, LIND & PONACK, L.L.P.  
Attn: Jeffrey R. Filipek, Esq.

Street Address: 2033 K Street, N.W., Suite 800

City: Washington, State: DC ZIP: 20006-1021

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41). . . . . \$40.00

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Jeffrey R. Filipek, Reg. No. 41,471  
Name of Person Signing

Signature

May 2, 2005  
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ATTACHMENT D

PATENT  
REEL: 017119 FRAME: 0951

# ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Takuya YAMAZAKI, Yasuhiro MAENISHI, Ikuo YOSHIDA, and

Akihito YAMASAKI

Insert Name(s)  
of Inventor(s)

the undersigned hereby sell(s) and assign(s) to

Insert Name(s)  
of Assignee(s)

Matsushita Electric Industrial Co., Ltd.

Address

of 1006, Oaza Kadoma, Kadoma-shi, Osaka 571-8501 Japan

(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

Title of  
Invention

COMPONENT MOUNTING SEQUENCE OPTIMIZING METHOD, COMPONENT MOUNTING DEVICE,  
PROGRAM FOR EXECUTING COMPONENT MOUNTING SEQUENCE OPTIMIZING METHOD,  
AND RECORDING MEDIUM IN WHICH THE PROGRAM IS RECORDED

Date of Signing  
of Application

for which an application for patent in the United States has been executed by the undersigned on  
March 15, March 16, March 28, 2005 respectively.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, DC 20006, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date March 15, 2005, Name of Inventor Takuya Yamazaki  
Takuya YAMAZAKI  
Date March 16, 2005, Name of Inventor Yasuhiko Maenishi  
Yasuhiko MAENISHI  
Date March 28, 2005, Name of Inventor Ikuo Yoshida  
Ikuo YOSHIDA  
Date March 15, 2005, Name of Inventor Akihito Yamasaki  
Akihito YAMASAKI  
Date \_\_\_\_\_, Name of Inventor \_\_\_\_\_  
Date \_\_\_\_\_, Name of Inventor \_\_\_\_\_

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness Setsumi Hoshimoto

Witness Yoshiko Yamaguchi

### ACKNOWLEDGEMENT

\_\_\_\_\_  
\_\_\_\_\_ } ss

This \_\_\_\_\_ day of \_\_\_\_\_, \_\_\_\_\_, before me  
personally came the above-named \_\_\_\_\_

to me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth.

SEAL \_\_\_\_\_  
Official Signature  
\_\_\_\_\_  
Official Title

The above application may be more particularly identified as follows:

U.S. Application Serial No. \_\_\_\_\_ Filing Date \_\_\_\_\_

Applicant Reference Number 541404 Atty Docket No. \_\_\_\_\_

Title of Invention COMPONENT MOUNTING SEQUENCE OPTIMIZING METHOD, COMPONENT MOUNTING DEVICE,  
PROGRAM FOR EXECUTING COMPONENT MOUNTING SEQUENCE OPTIMIZING METHOD, AND  
RECORDING MEDIUM IN WHICH THE PROGRAM IS RECORDED